

Security advisory TN1491-ST-PSIRT: Keccak XKCP SHA-3 reference implementation issue impact on STM32 products

Overview

This security advisory pertains to the Keccak XKCP SHA-3 open-source software reference implementation attack described in CVE-2022-37454, and its impact on STM32 products.

Affected products

Product	Version	Type	Note
X-CUBE-CRYPTOLIB	version 4.0.0, 4.0.1, and 4.1.0	embedded software	-

No STMicroelectronics STM32 hardware products are affected. However, the issue published regarding the Keccak XKCP SHA-3 open-source software can apply to the **X-CUBE-CRYPTOLIB** listed above if the following functions are made directly accessible by the application:

- SHA-3
- SHAKE
- EdDSA (only using the Edwards448 curve) signature generation and verification.

In particular, the X-CUBE-CRYPTOLIB is impacted if the user can fully control the input and/or the output sizes of the Keccak sponge function, by specifying sizes greater than or equal to $2^{32} - 200$ bytes.

Description

Refer to *Incorrect integer comparisons and buffer overflows*⁽¹⁾ and *CVE-2022-37454*⁽¹⁾.

Impact

The Keccak sponge function interface accepts partial inputs to be absorbed and partial outputs to be squeezed. A buffer can overflow when at least one partial data of size higher than or equal to $2^{32} - 200$ bytes is queued to the Keccak sponge function. To exploit the bug, it is not necessary to have this number of bytes, but it is just sufficient to provide that length to the Keccak function. Because of the bug, the function tries to read that quantity of bytes from the memory, most probably ending in a crash. In view of this, the user must consider the actual impact according to the final application.

Remediation

The issue can be avoided by limiting the size of the partial input data (or partial output digest) below $2^{32} - 200$ bytes. Multiple calls to the system queue can be chained at a higher level to retain the original functionality. Alternatively, one can process the entire input (or produce the entire output) at once, avoiding use of the Keccak sponge function with partial inputs/outputs.

Credit

Refer to *CVE-2022-37454*⁽¹⁾.

Contact information

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Revision history

Table 1. Document revision history

Date	Version	Changes
11-Oct-2023	1	Initial version.
11-Dec-2023	2	Removed Section <i>How to verify that the product is affected</i> and content moved to Section Affected products . Updated Section Affected products and Section Impact .

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